

OKI Semiconductor

MSC23CV23218D-xxBS4

2,097,152-word x 32-bit DYNAMIC RAM MODULE : FAST PAGE MODE TYPE

DESCRIPTION

The MSC23CV23218D-xxBS4 is a fully decoded, 2,097,152-word x 32-bit CMOS dynamic random access memory module composed of four 16Mb DRAMs (1Mx16) in TSOP packages mounted with eight decoupling capacitors on a 72-pin glass epoxy small outline package. This module supports any application where high density and large capacity of storage memory are required.

FEATURES

- 2,097,152-word x 32-bit organization
- 72-pin Small Outline Dual In-line Memory module
MSC23CV23218D-xxBS4 : Gold tab
- Single +3.3V supply $\pm 0.3V$ tolerance
- Input : LVTTL compatible
- Output : LVTTL compatible, 3-state
- Refresh : 1024cycles/16ms
- /CAS before /RAS refresh, hidden refresh, /RAS only refresh capability
- Fast page mode capability

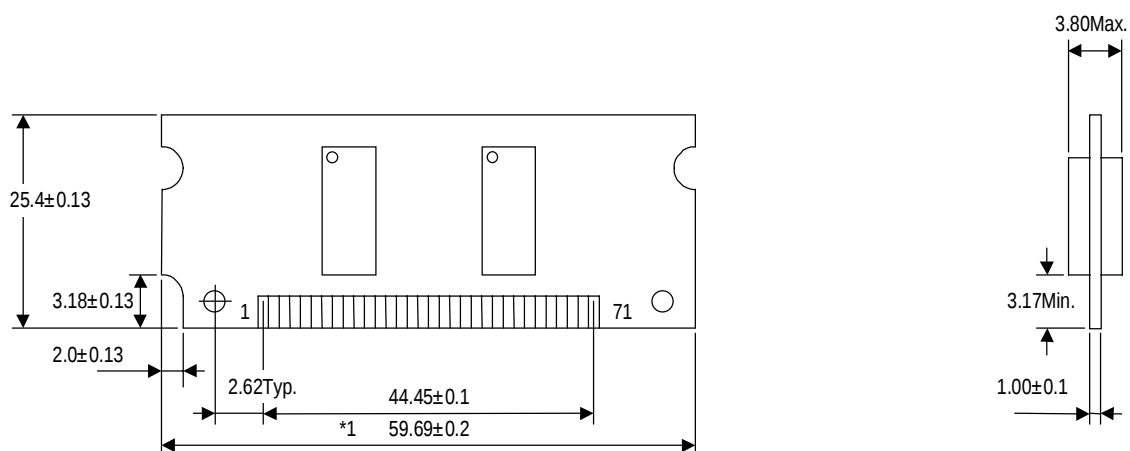
PRODUCT FAMILY

Family	Access Time (Max.)			Cycle Time (Min.)	Power Dissipation	
	t _{RAC}	t _{AA}	t _{CAC}		Operating (Max.)	Standby (Max.)
MSC23CV23218D-60BS4	60ns	30ns	15ns	110ns	864mW	7.2mW
MSC23CV23218D-70BS4	70ns	35ns	20ns	130ns	792mW	

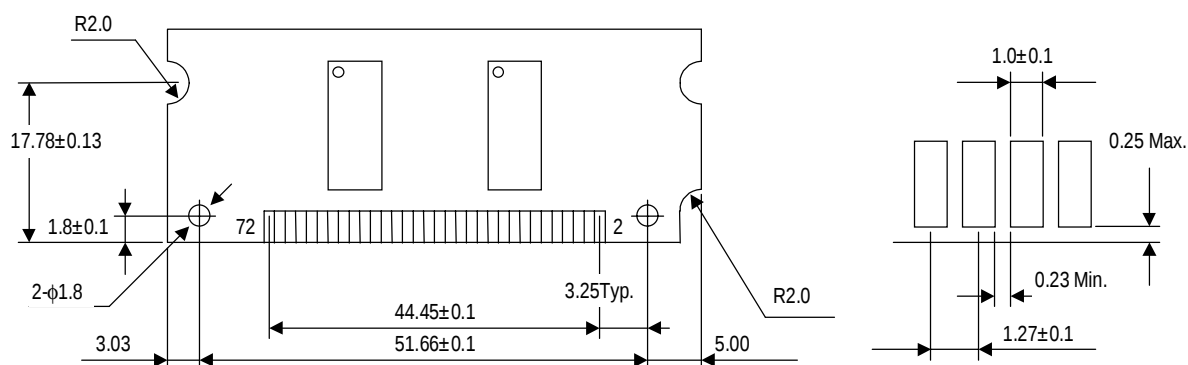
MODULE OUTLINE

MSC23CV23218D-xxBS4

(Unit : mm)



*1 The common size difference of the board width 19.78mm of its height is specified as ± 0.2 .
The value above 19.78mm is specified as ± 0.5 .



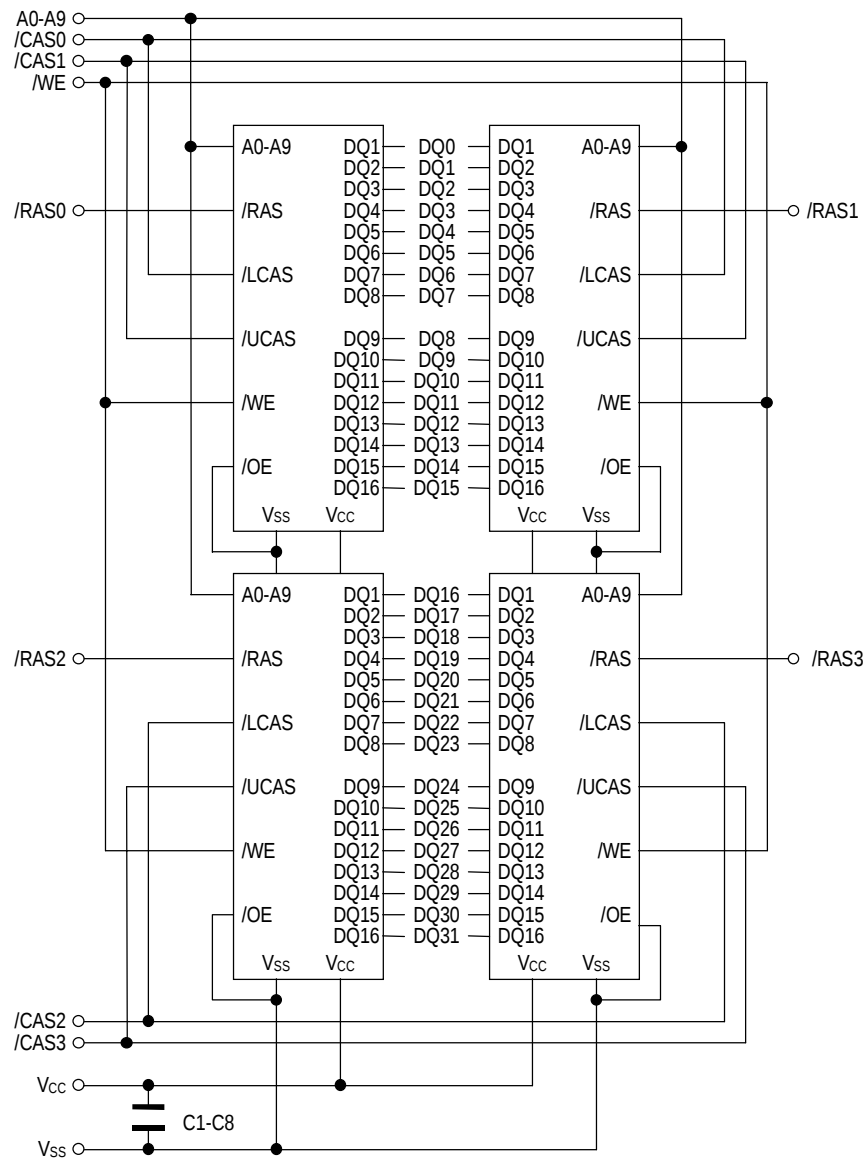
PIN CONFIGURATION

Front Side				Back Side			
Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name
1	V _{SS}	37	DQ16	2	DQ0	38	DQ17
3	DQ1	39	V _{SS}	4	DQ2	40	/CAS0
5	DQ3	41	/CAS2	6	DQ4	42	/CAS3
7	DQ5	43	/CAS1	8	DQ6	44	/RAS0
9	DQ7	45	/RAS1	10	V _{CC}	46	NC
11	PD1	47	/WE	12	A0	48	NC
13	A1	49	DQ18	14	A2	50	DQ19
15	A3	51	DQ20	16	A4	52	DQ21
17	A5	53	DQ22	18	A6	54	DQ23
19	A10	55	NC	20	NC	56	DQ24
21	DQ8	57	DQ25	22	DQ9	58	DQ26
23	DQ10	59	DQ27	24	DQ11	60	DQ28
25	DQ12	61	V _{CC}	26	DQ13	62	DQ29
27	DQ14	63	DQ30	28	A7	64	DQ31
29	NC	65	NC	30	V _{CC}	66	PD2
31	A8	67	PD3	32	A9	68	PD4
33	/RAS3	69	PD5	34	/RAS2	70	PD6
35	DQ15	71	PD7	36	NC	72	V _{SS}

Presence Detect Pins

Pin No.	Pin Name	-60	-70
11	PD1	NC	NC
66	PD2	V _{SS}	V _{SS}
67	PD3	V _{SS}	V _{SS}
68	PD4	NC	NC
69	PD5	NC	V _{SS}
70	PD6	NC	NC

BLOCK DIAGRAM



ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Voltage on Any Pin Relative to V_{SS}	V_{IN}, V_{OUT}	-0.5 to +4.6	V
Voltage on V_{CC} Supply Relative to V_{SS}	V_{CC}	-0.5 to +4.6	V
Short Circuit Output Current	I_{OS}	50	mA
Power Dissipation	P_D *	4	W
Operating Temperature	T_{OPR}	0 to +70	°C
Storage Temperature	T_{STG}	-40 to +125	°C

* $T_a = 25^\circ\text{C}$

Recommended Operating Conditions

($T_a = 0^\circ\text{C}$ to $+70^\circ\text{C}$)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Power Supply Voltage	V_{CC}	3.0	3.3	3.6	V
	V_{SS}	0	0	0	V
Input High Voltage	V_{IH}	2.0	-	$V_{CC}+0.3$	V
Input Low Voltage	V_{IL}	-0.3	-	0.8	V

Capacitance

($V_{CC} = 3.3\text{V} \pm 0.3\text{V}$, $T_a = 25^\circ\text{C}$, $f = 1\text{ MHz}$)

Parameter	Symbol	Typ.	Max.	Unit
Input Capacitance (A0 - A9)	C_{IN1}	-	31	pF
Input Capacitance (/WE)	C_{IN2}	-	35	pF
Input Capacitance (/RAS0- /RAS3)	C_{IN3}	-	13	pF
Input Capacitance (/CAS0- /CAS3)	C_{IN4}	-	20	pF
I/O Capacitance (DQ0 - DQ31)	C_{DQ}	-	20	pF

DC Characteristics

(V_{CC} = 3.3V ± 0.3V, Ta = 0°C to +70°C)

Parameter	Symbol	Condition	-60		-70		Unit	Note
			Min.	Max.	Min.	Max.		
Input Leakage Current	I _{LI}	0V ≤ V _{IN} ≤ V _{CC} +0.3V; All other pins not under test = 0V	-40	40	-40	40	μA	
Output Leakage Current	I _{LO}	DQ disable 0V ≤ V _{OUT} ≤ V _{CC}	-20	20	-20	20	μA	
Output High Voltage	V _{OH}	I _{OH} = -2.0mA	2.4	V _{CC}	2.4	V _{CC}	V	
Output Low Voltage	V _{OL}	I _{OL} = 2.0mA	0	0.4	0	0.4	V	
Average Power Supply Current (Operating)	I _{CC1}	/RAS, /CAS cycling, t _{RC} = Min.	-	240	-	220	mA	1, 2
Power supply current (Standby)	I _{CC2}	/RAS, /CAS = V _{IH}	-	8	-	8	mA	1
		/RAS, /CAS ≥ V _{CC} -0.2V	-	2	-	2	mA	1
Average Power Supply Current (/RAS only refresh)	I _{CC3}	/RAS cycling, /CAS = V _{IH} , t _{RC} = Min.	-	240	-	220	mA	1, 2
Average Power Supply Current (/CAS before /RAS refresh)	I _{CC6}	/RAS cycling, /CAS before /RAS	-	240	-	220	mA	1, 2
Average Power Supply Current (Fast Page Mode)	I _{CC7}	/RAS = V _{IL} , /CAS cycling, t _{PC} = Min.	-	170	-	160	mA	1, 3

- Notes: 1. I_{CC} Max. is specified as I_{CC} for output open condition.
 2. The address can be changed once or less while /RAS = V_{IL}.
 3. The address can be changed once or less while /CAS = V_{IH}.

AC Characteristics (1/2)

(V_{CC} = 3.3V ± 0.3V, T_a = 0°C to +70°C.) Note: 1, 2, 3

Parameter	Symbol	-60		-70		Unit	Note
		Min.	Max.	Min.	Max.		
Random Read or Write Cycle Time	t _{RC}	110	-	130	-	ns	
Fast Page Mode Cycle Time	t _{PC}	40	-	45	-	ns	
Access Time from /RAS	t _{RAC}	-	60	-	70	ns	4, 5, 6
Access Time from /CAS	t _{CAC}	-	15	-	20	ns	4, 5
Access Time from Column Address	t _{AA}	-	30	-	35	ns	4, 6
Access Time from /CAS Precharge	t _{CPA}	-	35	-	40	ns	4
Output Low Impedance Time from /CAS	t _{CLZ}	0	-	0	-	ns	4
/CAS to Data Output Buffer Turn-off Delay Time	t _{OFF}	0	15	0	20	ns	7
Transition Time	t _T	3	50	3	50	ns	3
Refresh Period	t _{REF}	-	16	-	16	ms	
/RAS Precharge Time	t _{RP}	40	-	50	-	ns	
/RAS Pulse Width	t _{RAS}	60	10K	70	10K	ns	
/RAS Pulse Width (Fast Page Mode)	t _{RASP}	60	100K	70	100K	ns	
/RAS Hold Time	t _{RSH}	15	-	20	-	ns	
/CAS Precharge Time (Fast Page Mode)	t _{CP}	10	-	10	-	ns	
/CAS Pulse Width	t _{CAS}	15	10K	20	10K	ns	
/CAS Hold Time	t _{CSH}	60	-	70	-	ns	
/CAS to /RAS Precharge Time	t _{CRP}	5	-	5	-	ns	
/RAS Hold Time from /CAS Precharge	t _{RHCP}	35	-	40	-	ns	
/RAS to /CAS Delay Time	t _{RCD}	20	45	20	50	ns	5
/RAS to Column Address Delay Time	t _{RAD}	15	30	15	35	ns	6
Row Address Set-up Time	t _{ASR}	0	-	0	-	ns	
Row Address Hold Time	t _{RAH}	10	-	10	-	ns	
Column Address Set-up Time	t _{ASC}	0	-	0	-	ns	
Column Address Hold Time	t _{CAH}	10	-	15	-	ns	
Column Address to /RAS Lead Time	t _{RAL}	30	-	35	-	ns	
Read Command Set-up Time	t _{RCS}	0	-	0	-	ns	
Read Command Hold Time	t _{RCH}	0	-	0	-	ns	8
Read Command Hold Time referenced to /RAS	t _{RRH}	0	-	0	-	ns	8

AC Characteristics (2/2)

(V_{CC} = 3.3V ± 0.3V, T_a = 0°C to +70°C) Note: 1, 2, 3

Parameter	Symbol	-60		-70		Unit	Note
		Min.	Max.	Min.	Max.		
Write Command Set-up Time	t _{WCS}	0	-	0	-	ns	
Write Command Hold Time	t _{WCH}	10	-	15	-	ns	
Write Command Pulse Width	t _{WP}	10	-	10	-	ns	
Write Command to /RAS Lead Time	t _{RWL}	15	-	20	-	ns	
Write Command to /CAS Lead Time	t _{CWL}	15	-	20	-	ns	
Data-in Set-up Time	t _{DS}	0	-	0	-	ns	
Data-in Hold Time	t _{DH}	10	-	15	-	ns	
/CAS Active Delay Time from /RAS Precharge	t _{RPC}	5	-	5	-	ns	
/RAS to /CAS Set-up Time (/CAS before /RAS)	t _{CSR}	10	-	10	-	ns	
/RAS to /CAS Hold Time (/CAS before /RAS)	t _{CHR}	10	-	10	-	ns	

- Notes:
1. A start-up delay of 200 μ s is required after power-up, followed by a minimum of eight initialization cycles (/RAS only refresh or /CAS before /RAS refresh) before proper device operation is achieved.
 2. The AC characteristics assumes $t_T = 5$ ns.
 3. $V_{IH}(\text{Min.})$ and $V_{IL}(\text{Max.})$ are reference levels for measuring input timing signals. Transition time (t_T) are measured between V_{IH} and V_{IL} .
 4. This parameter is measured with a load circuit equivalent to 1TTL loads and 100pF.
The output timing reference levels are $V_{OH} = 2.0$ V and $V_{OL} = 0.8$ V.
 5. Operation within the $t_{RCD}(\text{Max.})$ limit ensures that $t_{RAC}(\text{Max.})$ can be met.
 $t_{RCD}(\text{Max.})$ is specified as a reference point only. If t_{RCD} is greater than the specified $t_{RCD}(\text{Max.})$ limit, then the access time is controlled by t_{CAC} .
 6. Operation within the $t_{RAD}(\text{Max.})$ limit ensures that $t_{RAC}(\text{Max.})$ can be met.
 $t_{RAD}(\text{Max.})$ is specified as a reference point only. If t_{RAD} is greater than the specified $t_{RAD}(\text{Max.})$ limit, then the access time is controlled by t_{AA} .
 7. $t_{OFF}(\text{Max.})$ define the time at which the output achieves the open circuit condition and are not referenced to output voltage levels.
 8. t_{RCH} or t_{RRH} must be satisfied for a read cycle.